

IN THE CLAIMS

Please amend claims 1-6, 8-10, 12-20, 23, 26, 30, 33, and 36 as follows below.

Please add new claims 39-40 as follows below.

The following listing of claims replaces all prior versions, and listings, of claims in the application:

Listing of Marked-up Claims

1. (Currently Amended) An integrated circuit comprising:
one or more functional blocks to perform one or more functions; and
a an-on-chip frequency compensation circuit including
a selectively enabled reliability oscillator to generate a reference oscillating signal,
a ~~eleected~~ degraded reliability oscillator to generate a [[an AC]] degraded
oscillating signal, and
a compare circuit coupled to the reliability oscillators, the compare circuit to
compare the oscillating signals and to generate a frequency compensation signal in
response to the comparison being greater than a predetermined threshold.
2. (Currently Amended) The integrated circuit of claim 1, wherein
the on-chip frequency compensation circuit further includes
a first counter coupled between the selectively enabled reliability oscillator and
the compare circuit, the first counter to generate a first reference count;
a second counter coupled between the ~~eleected~~ degraded reliability oscillator and
the compare circuit, the second counter to generate a dynamie second degraded count;
and
the compare circuit to compare the first reference count with the dynamie second
degraded count.
3. (Currently Amended) The integrated circuit of claim 2, wherein
the on-chip frequency compensation circuit further includes

a first prescaler coupled between the selectively enabled reliability oscillator and the first counter, the first prescaler to divide by N the number of oscillations in an oscillating signal from the selectively enabled reliability oscillator; and

a second prescaler coupled between the dynamic reliability oscillator and the second counter, the second prescaler to divide by N the number of oscillations in an oscillating signal from the dynamic degraded reliability oscillator.

4. (Currently Amended) The integrated circuit of claim 1, wherein the degraded reliability oscillator is a clocked reliability oscillator to generate an AC degraded oscillating signal; and

the on-chip frequency compensation circuit further includes a static reliability oscillator to generate a DC bias degraded oscillating signal.

5. (Currently Amended) The integrated circuit of claim 4, wherein the on-chip frequency compensation circuit further includes

a first counter coupled between the selectively enabled reliability oscillator and the compare circuit, the first counter to generate a reference count;

a second counter coupled between the clocked reliability oscillator and the compare circuit, the second counter to generate a dynamic count;

a third counter coupled between the static reliability oscillator and the compare circuit, the third counter to generate a static count; and

the compare circuit to compare the reference count with the dynamic count and the reference count with the static count.

6. (Currently Amended) The integrated circuit of claim 5, wherein the on-chip frequency compensation circuit further includes

a first prescaler coupled between the selectively enabled reliability oscillator and the first counter, the first prescaler to divide by N the number of oscillations in an oscillating signal from the selectively enabled reliability oscillator;

a second prescaler coupled between the dynamic reliability oscillator and the second counter, the second prescaler to divide by N the number of oscillations in an oscillating signal from the dynamic reliability oscillator; and

a third prescaler coupled between the static reliability oscillator and the third counter, the third prescaler to divide by N the number of oscillations in an oscillating signal from the static reliability oscillator.

7. (Original) The integrated circuit of claim 1, wherein the integrated circuit is a microprocessor.

8. (Currently Amended) The [[An]] integrated circuit of claim 1, wherein comprising:
~~one or more functional blocks; and~~
~~an on-chip frequency compensation circuit including~~
~~a selectively enabled reliability oscillator to generate a reference oscillating signal,~~
~~the degraded reliability oscillator is a static reliability oscillator to generate a DC bias~~
degraded oscillating signal, and

~~a compare circuit coupled to the reliability oscillators, the compare circuit to compare the reference oscillating signals signal and the DC bias degraded oscillating signal to generate [[a]] the frequency compensation signal in response to the comparison being greater than [[a]] the predetermined threshold.~~

9. (Currently Amended) The integrated circuit of claim 8, wherein the on-chip frequency compensation circuit further includes
a first counter coupled between the selectively enabled reliability oscillator and the compare circuit, the first counter to generate a reference count;
a second counter coupled between the static reliability oscillator and the compare circuit, the second counter to generate a static count;
and
the compare circuit to further compare the reference count with the static count.

10. (Currently Amended) The integrated circuit of claim 9, wherein the ~~on-chip~~ frequency compensation circuit further includes
 - a first prescaler coupled between the selectively enabled reliability oscillator and the first counter, the first prescaler to divide by N the number of oscillations in an oscillating signal from the selectively enabled reliability oscillator; and
 - a second prescaler coupled between the dynamic reliability oscillator and the second counter, the second prescaler to divide by N the number of oscillations in an oscillating signal from the static reliability oscillator.
11. (Original) The integrated circuit of claim 8, wherein the integrated circuit is a microprocessor.
12. (Currently Amended) An integrated circuit comprising:
one or more functional blocks to perform one or more functions; and
~~a~~ ~~an~~ ~~on-chip~~ frequency compensation circuit including
 - a first reliability oscillator including a selectively powered on ring oscillator to avoid transistor degradation, the first reliability oscillator to generate a reference oscillating signal on a first oscillation output,
 - a second reliability oscillator including a constantly powered ring oscillator to experience transistor degradation, the second reliability oscillator to generate a degraded oscillating signal on a second oscillation output, and
 - a compare circuit to compare the reference oscillating signal and the degraded oscillating signal to generate a frequency compensation signal in response to the comparison being greater than a predetermined threshold
 - ~~a first counter having an input to couple to the first oscillation output, the first counter to generate a reference count on a first count output, and~~
 - ~~a second counter having an input to couple to the second oscillation output, the second counter to generate a degraded count on a second count output.~~
13. (Currently Amended) The integrated circuit of claim [[12]] 40, wherein

the ~~on-chip~~ frequency compensation circuit further includes

 a first prescaler coupled between the first reliability oscillator and the first counter, the first prescaler to divide by N the number of oscillations in the reference oscillating signal; and

 a second prescaler coupled between the second reliability oscillator and the second counter, the second prescaler to divide by N the number of oscillations in the degraded oscillating signal.

14. (Currently Amended) The integrated circuit of claim [[12]] 40, wherein the second reliability oscillator includes a constantly powered static ring oscillator to experience DC static transistor degradation,

 the degraded oscillating signal is [[an]] ~~a~~ DC bias degraded oscillating signal on the second oscillation output, and

 the degraded count is a static count.

15. (Currently Amended) The integrated circuit of claim [[12]] 40, wherein the second reliability oscillator includes a constantly powered clocked ring oscillator to experience AC dynamic transistor degradation,

 the degraded oscillating signal is an AC degraded oscillating signal on the second oscillation output, and

 the degraded count is a dynamic count.

16. (Currently Amended) The integrated circuit of claim 15, wherein the ~~on-chip~~ frequency compensation circuit further includes

 a third reliability oscillator including a constantly powered static ring oscillator to experience DC static transistor degradation, the third reliability oscillator to generate a DC bias degraded oscillating signal on a third oscillation output, and

 a third counter having an input to couple to the third oscillation output, the third counter to generate a static count on a third count output.

17. (Currently Amended) The integrated circuit of claim 16, wherein the ~~on-chip~~ frequency compensation circuit further includes
 - a first prescaler coupled between the first reliability oscillator and the first counter, the first prescaler to divide by N the number of oscillations in the reference oscillating signal,
 - a second prescaler coupled between the second reliability oscillator and the second counter, the second prescaler to divide by N the number of oscillations in the dynamic oscillating signal, and
 - a third prescaler coupled between the third reliability oscillator and the third counter, the third prescaler to divide by N the number of oscillations in the static oscillating signal.
18. (Currently Amended) The integrated circuit of claim 13, wherein the ~~on-chip~~ frequency compensation circuit further includes a state machine to start and stop the counting by the counters.
19. (Currently Amended) The integrated circuit of claim 13, wherein the first counter includes a count overflow output and a count enable input, the count overflow output being a stop signal is coupled to the count enable input to stop the first counter from counting further, and the ~~on-chip~~ frequency compensation circuit further includes
 - a first synchronizer having an input coupled to the count overflow output and an output coupled to a count enable input of the second counter, the first synchronizer to synchronize the stop signal to stop the second counter from counting further.
20. (Currently Amended) The integrated circuit of claim 16, wherein the first counter includes a count overflow output and a count enable input, the count overflow output being a stop signal is coupled to the count enable input to stop the first counter from counting further, and the ~~on-chip~~ frequency compensation circuit further includes

a first synchronizer having an input coupled to the count overflow output and an output coupled to a count enable input of the second counter, the first synchronizer to synchronize the stop signal to stop the second counter from counting further, and

a second synchronizer having an input coupled to the count overflow output and an output coupled to a count enable input of the third counter, the second synchronizer to synchronize the stop signal to stop the third counter from counting further.

21. (Original) The integrated circuit of claim 12, wherein a clock signal is coupled into a clock input of the second reliability oscillator.

22. (Original) The integrated circuit of claim 12, wherein the integrated circuit is a microprocessor.

23. (Currently Amended) A method in an integrated circuit with functional blocks, the method comprising:

enabling measurement of ring oscillator frequencies of ~~a trio of~~ two ring oscillators; measuring a first frequency of a first ring oscillator having non-stressed transistors; measuring a second frequency of a second ring oscillator having stressed transistors; comparing the first frequency with the second frequency to determine a first measure of transistor degradation.

24. (Original) The method of claim 23, wherein the stressed transistors of the second ring oscillator are dynamically stressed transistors.

25. (Original) The method of claim 23, wherein the stressed transistors of the second ring oscillator are statically stressed transistors.

26. (Currently Amended) The method of claim 25, further comprising enabling measurement of a ring oscillator frequency of a third ring oscillator;

measuring a third frequency of [[a]] the third ring oscillator having dynamically stressed transistors; and

comparing the first frequency with the third frequency to determine a second measure of transistor degradation.

27. (Original) The method of claim 23 further comprising:
performing one or more functions with the functional blocks.

28. (Original) The method of claim 27, wherein
the functional blocks include an execution unit to execute instructions; and
the integrated circuit is a microprocessor.

29. (Original) The method of claim 23, wherein
the first ring oscillator and the second ring oscillator have substantially similar circuits.

30. (Currently Amended) The method of claim 29, wherein
the [[the]] second ring oscillator has degraded transistors; and
the first ring oscillator has transistors without degradation.

31. (Original) The method of claim 23, wherein
the comparing determines a new clock ratio,
and if the new clock ratio is less than an initial clock ratio multiplied by a guard band,
then the new clock ratio is output to a clock generator.

32. (Original) The method of claim 31, further comprising
generating a clock signal using the new clock ratio.

33. (Currently Amended) A microprocessor integrated circuit comprising:
an execution unit to execute instructions; and
a ~~an~~ ~~integrated on chip~~ frequency compensation circuit including

a reference reliability oscillator to selectively generate a reference oscillating signal,

a degrading reliability oscillator to selectively generate a degraded oscillating signal, and

a measurement and comparison circuit coupled to the reliability oscillators, the measurement and comparison circuit to receive the reference oscillating signal and the degrading oscillating signal to generate a first measure of transistor degradation, ~~the measurement and comparison circuit to receive the reference oscillating signal and the degraded oscillating signal to generate a second measure of transistor degradation.~~

34. (Original) The microprocessor integrated circuit of claim 33, wherein the degrading reliability oscillator is a dynamic reliability oscillator that selectively generates an AC degraded oscillating signal.

35. (Original) The microprocessor integrated circuit of claim 33, wherein the degrading reliability oscillator is a static reliability oscillator that selectively generates a DC degraded oscillating signal.

36. (Currently Amended) The microprocessor integrated circuit of claim 35, ~~further comprising wherein the frequency compensation circuit further includes~~

a dynamic reliability oscillator to selectively generate an AC degraded oscillating signal, and

the measurement and comparison circuit ~~further to receive the reference oscillating signal and the AC degraded oscillating signal to generate a [[first]] second measure of transistor degradation, the measurement and comparison circuit to receive the reference oscillating signal and the DC degraded oscillating signal to generate a second measure of transistor degradation.~~

37. (Original) The microprocessor integrated circuit of claim 36, wherein

the measurement and compare circuit further to compare the first measure of transistor degradation with the second measure of transistor degradation to determine a worst transistor degradation.

38. (Original) The microprocessor integrated circuit of claim 37, wherein the measurement and compare circuit to generate a frequency compensation signal in response to the worst transistor degradation being greater than a predetermined level.

39. (New) The integrated circuit of claim 1, wherein the degraded reliability oscillator is a clocked reliability oscillator to generate an AC degraded oscillating signal; and

the compare circuit to compare the reference oscillating signal and the AC degraded oscillating signal to generate the frequency compensation signal in response to the comparison being greater than the predetermined threshold.

40. (New) The integrated circuit of claim 12, wherein the frequency compensation circuit further includes

a first counter having an input to couple to the first oscillation output, the first counter to generate a reference count on a first count output, and

a second counter having an input to couple to the second oscillation output, the second counter to generate a degraded count on a second count output; and

the compare circuit to compare the reference count and the degraded count to compare the reference oscillating signal and the degraded oscillating signal to generate the frequency compensation signal in response to the comparison of the counts being greater than a predetermined threshold.